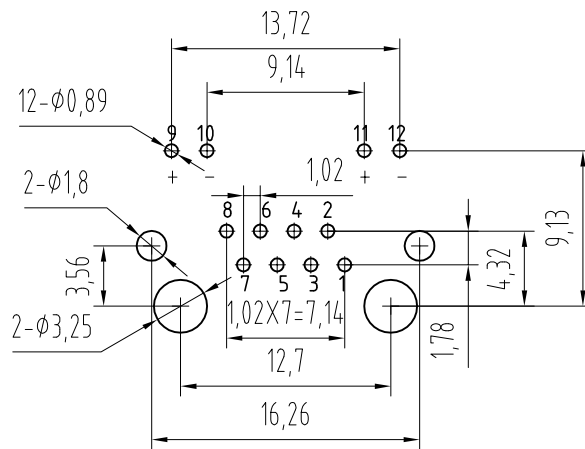
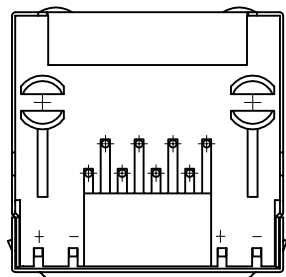
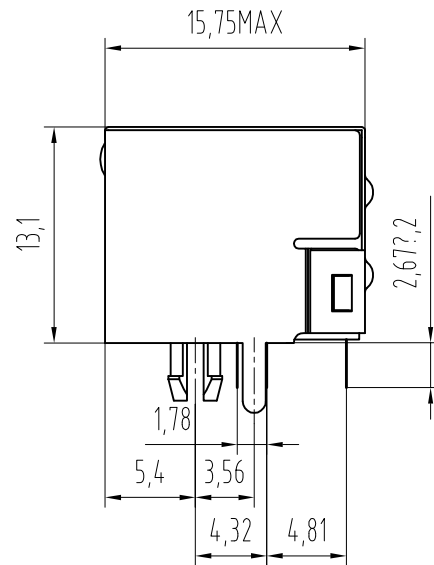
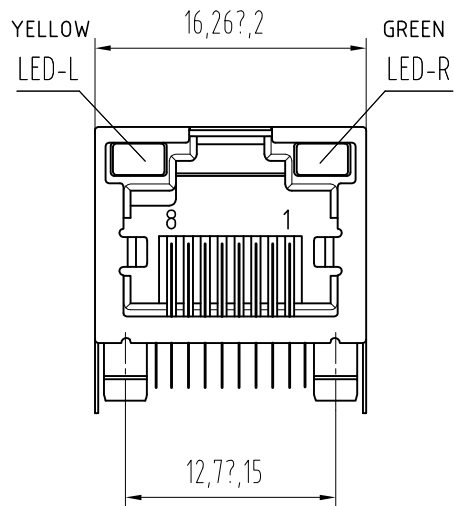




PC Board Layout
Component Side Shown

NOTES:

MATERIAL :

- 1.HOUSING MATERIAL :GLASS FILLED POLYESTER UL94V-0.
- 2.CONTACT MATERIAL :PHOSPHOR BRONZE $\phi 0.46\text{mm}$.
- 3.PLATING :GOLD PLATING OVER NICKEL.
- 4.SHIELD :0.23mm THICKNESS COPPER ALLOY WITH NICKEL PLATED.
- 5.LED :OPTION

ELECTRICAL:

- 1.VOLTAGE RATING :125 VAC RMS.
- 2.CURRENT RATING :1.5 AMP.
- 3.CONTACT RESISTANCE :30 MILLIOHMS MAX.
- 4.INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC .
- 5.DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.

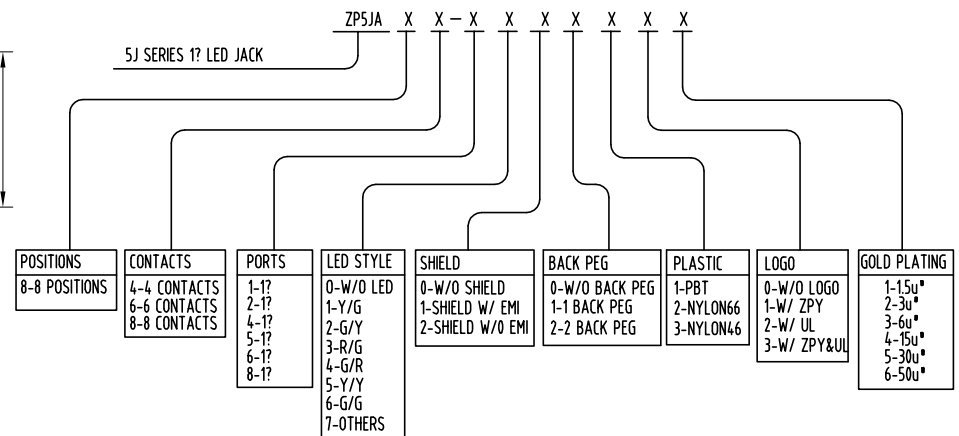
MECHANICAL:

- 1.DURRABILITY :750 CYCLES MIN.
- 2.PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40℃~+85℃
2. OPERATION : 0? TO 70?.

PART NUMBER:



MM (INCH) TOLERANCES EXCEPT AS NOTED MM ± 0.15 ± 0.075 ± 0.05 ANGLES ± 0.5 THIRD ANGLE PROJECTION	DFTO SHB CHKD LANBO MFO APPLV	DATE 2007.05.05 DATE 2007.05.05 DATE DATE	LXW 连兴旺电子(深圳)有限公司 LXWCON ELECTRONICS (SHENZHEN) CO., LTD	
	MATERIAL :		TITLE	
	QT'Y :		75JA SERIES 1? LED JACK SHIELDED	
	FINISH :		DRAWING NO. TESJA1002	SIZE A3

LXW 连兴旺电子(深圳)有限公司
LXWCON ELECTRONICS (SHENZHEN) CO., LTD

75JA SERIES 1? LED JACK SHIELDED

DRAWING NO. TESJA1002		SIZE A3	REV 0
/PART NO. 75JA-1X1-8P8C-LED-S		SHEET X OF Y	
DO NOT SCALE DRAWING		DO NOT SCALE DRAWING	